## Jumper Chip

### Hokuriku Electric Industry Co.,Ltd HDI



# [Model Number] JPC\*\*

#### [Features]

- ■This is special sized jumper chip product.
- Since all sizes have common width of 0.5mm, usability around tight circuit pattern improves.
- Complex wiring design will be eased, and freedom of circuit design increases.
- Since sizes of 4mm or longer use glass-epoxy substrate, benting strength•impact resistance are vastly improved.
- Availability of supply by taping enables mounting by normal mounter.
- Reflow, Flow solderings are applicable.
- Europe RoHS compliant product.



#### [Dimensions]

(Unit:mm)

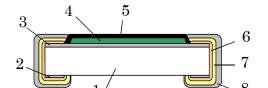
<b>—</b>	L
<u> </u>	• c
t	w w
<b>†</b>	→ d <i>→</i>

Model No.	L	W	t	С	d
JPC20	2.00±0.15	0.50±0.10	0.35±0.05	0.25±0.10	0.25±0.10
JPC30	3.00±0.15	0.50±0.10	0.35±0.05	0.25±0.10	0.25±0.10
JPC40	4.00±0.15	0.50±0.10	0.35±0.05	0.25±0.10	0.25±0.10
JPC50	5.00±0.15	0.50±0.10	0.35±0.05	0.25±0.10	0.25±0.10
JPC60	6.00±0.15	0.50±0.10	0.35±0.05	0.25±0.10	0.25±0.10

[Specification]

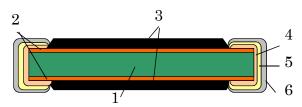
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	Model No.	Rated current	Internal resistance
	JPC20		
	JPC30	1. <b>4A</b>	50 mΩ or less
	JPC40		
	JPC50		
	JPC60		

#### [Structure] JPC20 / JPC30



No.	Element Name
1	Ceramic substrate
2	Back electrode
3	Conductor
4	Protective coat I
5	Protective coat II
6	Side electrode
7	Ni plating
8	Sn plating

#### JPC40 / JPC50 / JPC60



No.	Element Name
1	Glass epoxy substrate
2	Conductor
3	Overcoat
4	Side electrode
5	Ni plating
6	Sn plating

<sup>\*</sup> Design \* specification are subject to change without prior notice. Please check before purchase and use.